



PRODUCT DATASHEET

- CSP CHIP LED
- 2020 0.94t Series

Warm White (2700K)



2020 0.94t Series

ATTENTION

OBSERVEPRECAUTIO



UTOMOTIVE



- Package: Ceramic High Power CSP Package
- Forward Current: 350~500mA
- Forward Voltage (typ.): 9.0V
- Luminous Flux (typ.): 310lm@350mA
- Colour: Warm White
- CCT/Colour Temperature (typ.): 2600~3000K
- Viewing angle: 115°
- Materials:
 - Die: Flip-Chip InGaN
 - Resin: Silicon (Yellow Diffused)
 - L/T Finish: Ag plated
- Operating Temperature: -40~+125°C
- Storage Temperature: -40~+125°C
- Grouping parameters:
 - Forward Voltage
 - Luminous Flux
 - CIE Chromaticity
- Soldering methods: IR Reflow
- Preconditioning: MSL2 according to J-STD020
- Packing: 8mm tape with max.1000pcs /reel, ø180mm (7")



N0W53S56

- **APPLICATIONS:**
- Automotive Lightning
- Decorative Lighting
- Portable Lighting
- Outdoor Lighting
- Commercial Lighting
- Indoor Lighting

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Industrial Lighting



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
DC Forward Current	lf	500	mA
Reverse Voltage	V _R	12	V
Junction Temperature	Tj	150	°C
Thermal Resistance Junction to Solder Point	R _{th(J-S)}	4	°C/W
Temperature Coefficient of Voltage		-2.5	mV/°C
Operating Temperature	Topr	-40~+125	°C
Storage Temperature	Т _{stg}	-40~+125	°C
Colour Rendering Index / Ra	CRI	80	

Electrical & Optical Characteristics (Ta=25°C)

Parameter	Symbol	Values			Unit	Test	
Parameter	Symbol	Min.	Тур.	Max.	Onit	Condition	
Forward Voltage	VF	8.5	9.0	10.0	V	I⊧=350mA	
Luminous Flux	Φv	280	310	340	lm	I⊧=350mA	
Chromaticity Coordinates	х		0.4578			I⊧=350mA	
	Y		0.4101				
ССТ		2600		3000	к	I⊧=350mA	
Viewing Angle	2 0 1/2		115		deg	I⊧=350mA	

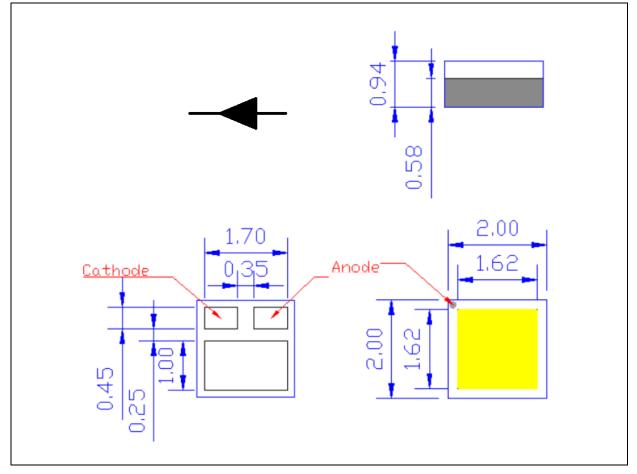
1. Luminous flux (Φ_V) ±7%, Forward Voltage (V_F) ±0.05V, Viewing angle(2 $\theta_{1/2}$) ±10°, CRI ±2

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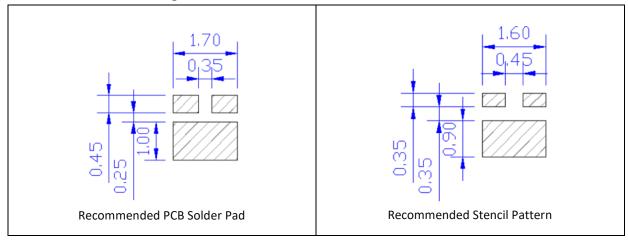
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ± 0.13 mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ± 0.12 mm with angle tolerance $\pm 0.5^{\circ}$.



BINNING GROUPS:

Code	Min.	Max.	Unit
BP	8.5	8.8	
BQ	8.8	9.1	V
BR	9.1	9.4	V
BS	9.4	9.7	

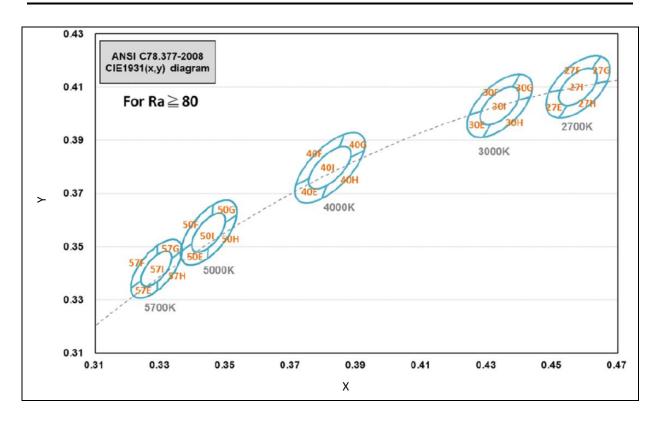
Forward Voltage Classifications (I_F = 350mA):

Luminous Flux Classifications (I_F = 350mA):

Code	Min.	Max.	Unit	
U14	280	300		
U15	300	320	lm	
U16	320	340		



CIE CHROMATICITY DIAGRAM:

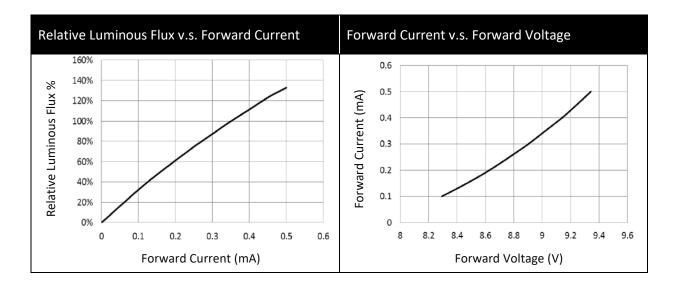


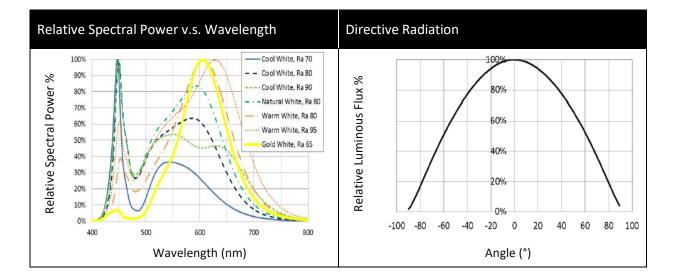
Chromaticity Coordinates Classifications (I_F = 350mA):

	Cada	Centre		Radius		Angle
a	Code	Х	Y	а	b	Φ
	3-STEP (27I)	0.4578	0.4101	0.00810	0.00420	53.70
	5-STEP	0.4578	0.4101	0.01350	0.00700	53.70



ELECTRO-OPTICAL CHARACTERISTICS:

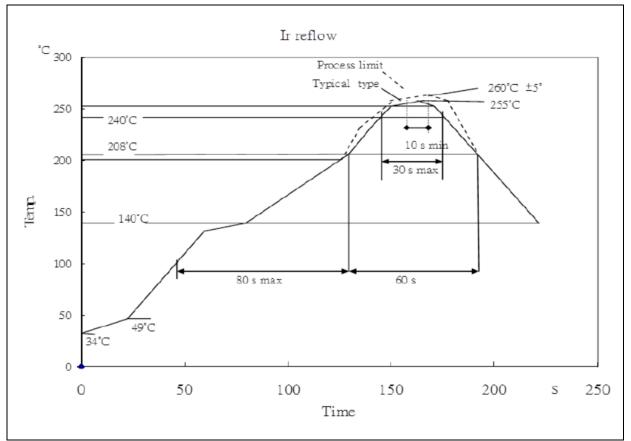




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RECOMMENDED SOLDERING PROFILE:



Reflow Lead-free Solder:

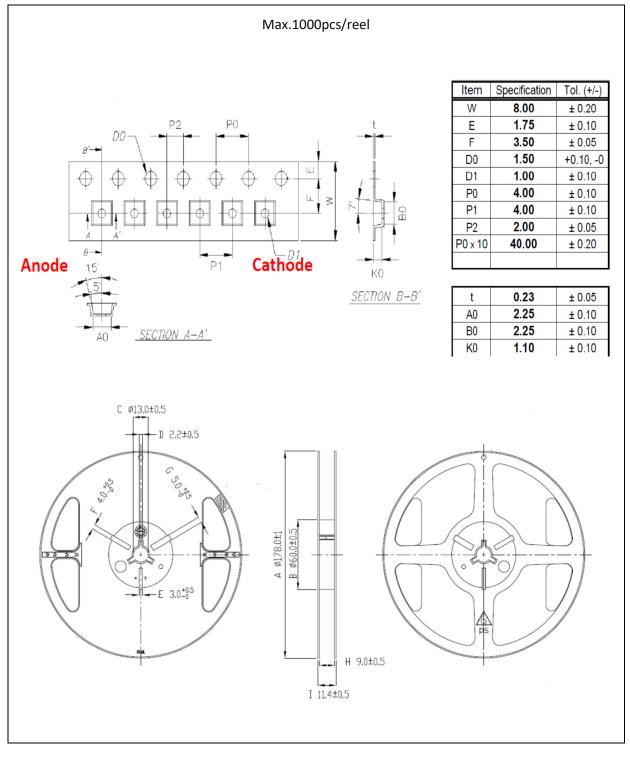
Note:

- 1. Maxima reflow soldering: 1 time.
- 2. The recommended reflow temperature is 240°C. The maximum soldering temperature should be limited to 260°C.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

Reel Dimension:



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PRECAUTIONS OF USE:



Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

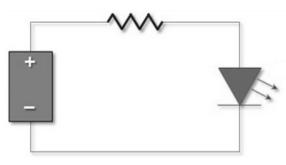
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	06/11/2020	Datasheet set-up.
A1.1	30/11/2021	New datasheet format.